IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				der both This leve	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Form Type Distribute				Form Type * Distribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and M	fg Informa	tion	
upplier Inform	ation														
Company name*			Company unique ID			U	Unique ID Authority					Response Date*			
nsemi												2023-06-08			
ontact Name		Title - Contact			P	Phone - Contact*					Email - Contact*				
Product-Env-Stewar	rds	Product Enviro Compliance			l N	NA					Product-Env-Stewards@onsemi.com				
uthorized Represer	ntative*	Title - Representative			P	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com				
Requester	ster Item Number Mfr Item		n Number Mfr Item Name]	Effective Da	te Vers	ion	Manufacturing Site			Weight*	UOM	Unit Type
		driver		3PH DRV SENSOR CLOSE; Three phase driver with hall sensor method (closed loop speed control)			2023-06-08		РНМ		:	350.0	mg	Each	
Ianufacturing I	Proccess Information	n													
Terminal Plating / Grid Array Material To			Terminal Base Alloy J-STD-020 MSL		STD-020 MSL Rat	ting	Peak Process Body Temperature Max Time at		e at Peak	ak Temperature Number of Reflow Cycles					
contains Bi			CU Alloy 3				260 C 30			seconds 3					
omments															
TTENTION: MSL	3 Rated item requires Ba	ake and D	ry Pack (after	electrical test)											
or more informatio	on regarding material con	nposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.25	mg	Supplier	Silicon (Si)	7440-21-3		5.2306	mg
			Supplier	Polyimide	Proprietary Data		0.0194	mg
Die Attach	0.42	mg	Supplier	Silver (Ag)	7440-22-4		0.357	mg
			Supplier	Epoxy resins	129915-35-1		0.0567	mg
			Supplier	Polybutadiene polymer	Proprietary Data		0.0063	mg
Lead Frame	123.0	mg	Supplier	Zinc (Zn)	7440-66-6		0.2337	mg
			Supplier	Iron (Fe)	7439-89-6		3.1857	mg
			Supplier	Copper (Cu)	7440-50-8		119.4084	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1722	mg
Mold Compound-Black	217.12	mg		Phenolic Resin	proprietary data		10.856	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		6.0794	mg
			Supplier	Carbon Black (C)	1333-86-4		2.1712	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		6.5136	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		173.696	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		17.3696	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.4342	mg
Plating	3.85	mg	В	Bismuth (Bi)	7440-69-9		0.0231	mg
			Supplier	Tin (Sn)	7440-31-5		3.8269	mg
Wire Bond - Cu	0.36	mg	Supplier	Copper (Cu)	7440-50-8		0.36	mg